**M5M29GB/T320VP-80** 33,554,432-BIT (4,194,304-WORD BY 8-BIT / 2,097,152-WORD BY16-BIT)

CMOS 3.3V-ONLY, BLOCK ERASE FLASH MEMORY

#### DESCRIPTION

The Mobile FLASH M5M29GB/T320VP are 3.3V-only high speed 33,554,432-bit CMOS boot block Flash Memories with alternating BGO (Back Ground Operation) feature. The BGO feature of the device allows Program or Erase operations to be performed in one bank while the device simultaneously allows Read operations to be performed on the other bank. This BGO feature is suitable for mobile and personal computing, and communication products. The M5M29GB/T320VP are fabricated by CMOS technology for the peripheral circuits and DINOR(Divided bit line NOR) architecture for the memory cells, and are available in 48pin TSOP(I).

## FEATURES

<ul> <li>Organization</li> </ul>		2,097,152 word x 16bit
		4,194,304 word x 8 bit
<ul> <li>Supply voltage</li> </ul>		Vcc = 2.7 ~ 3.6V
Access time		80ns (Vcc=3.0~3.6V) 90ns (Vcc=2.7~3.6V)
Program/Era Standby • Deep power do	natic Power saving) ase wn mode or Bank(I) and Bank(II)	72 mW (Max. at 5MHz) 0.33µW (typ.) 126mW (Max.) 0.33µW (typ.) 0.33µW (typ.)
(Page P	ogram) ····· rogram) ····· or Bank(III) and Bank(IV)	
	•	
	Boot Block ·····	4Kword/8Kbyte x 2
Bank(II)   Bank(III)	Main Block ······ Main Block ····· Main Block ·····	<ul> <li>32Kword/64Kbyte x 7</li> <li>32Kword/64Kbyte x 8</li> <li>32Kword/64Kbyte x 24</li> <li>32Kword/64Kbyte x 24</li> </ul>
<ul> <li>Program/Erase</li> </ul>	cycles ·····	······ 100Kcycles

<ul> <li>Boot Block</li> </ul>	
M5M29GB320VP	·····Bottom Boot
M5M29GT320VP	·····Top Boot

Renesas LSIs

 Other Functions Soft Ware Command Control Selective Block Lock Status Register Read Alternating Back Ground Program/Erase Operation Between Bank(I), Bank(II), Bank(III) and Bank(IV)

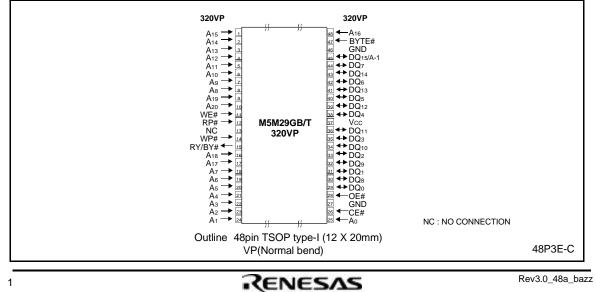
Package

48-Lead, 12mm x 20mm TSOP (type-I)

### APPLICATION

Code Strage Digital Cellular Phone Telecommunication Mobile Computing Machine PDA (Personal Digital Assistance) Car Navigation System Video Game Machine

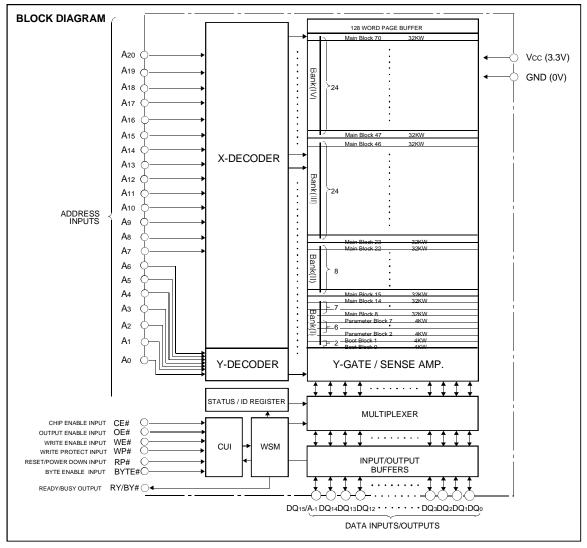
#### **PIN CONFIGURATION (TOP VIEW)**



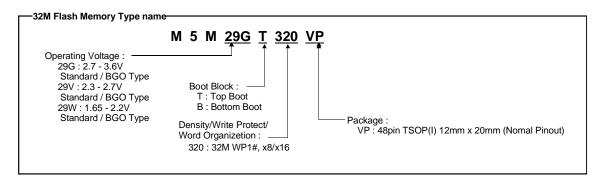
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Renesas LSIs M5M29GB/T320VP-80

33,554,432-BIT (4,194,304-WORD BY 8-BIT / 2,097,152-WORD BY16-BIT) CMOS 3.3V-ONLY, BLOCK ERASE FLASH MEMORY







2

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Nippon Bldg.,6-2,Otemachi 2-chome,Chiyoda-ku,Tokyo,100-0004 Japan

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